

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10749103			
<b>Filing Date:</b>	30-Dec-2003			
<b>Title of Invention:</b>	METHOD OF FORMING A MULTI-LAYER SEMICONDUCTOR STRUCTURE INCORPORATING A PROCESSING HANDLE MEMBER			
<b>First Named Inventor/Applicant Name:</b>	Rafael Reif			
<b>Filer:</b>	Kermit Robinson/Mary H. White			
<b>Attorney Docket Number:</b>	MIT-136BUS			
Filed as Large Entity				
<b>Utility under 35 USC 111(a) Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Certificate of correction	1811	1	100	100
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				100